

Photocouplers Photorelay

TLP3555

1. Applications

- · Mechanical relay replacements
- · Security Systems
- · Measuring Instruments
- Factory Automation (FA)
- · Amusement Equipment

2. General

The TLP3555 photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 4-pin DIP package. The low ON-state resistance and the high permissible ON-state current of the the TLP3555 make it suitable for power line control applications.

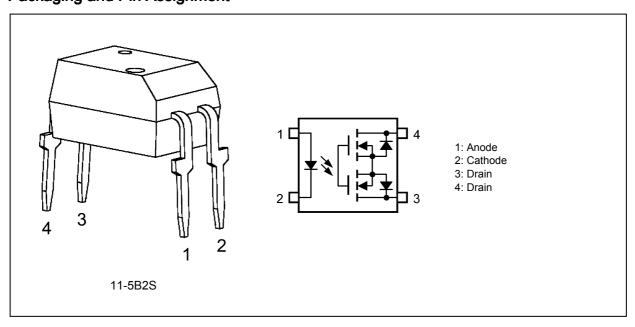
3. Features

- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 2 A (max)
- (5) ON-state resistance: $200 \text{ m}\Omega \text{ (max)}$
- (6) Isolation voltage: 2500 Vrms (min)
- (7) Safety standards

UL-recognized: UL 1577, File No.E67349

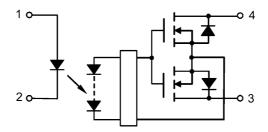
cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

4. Packaging and Pin Assignment





5. Internal Circuit



6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I _F		30	mA
	Input forward current derating $(T_a \ge 2)$	25 °C)	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed) (100 μs puls	se, 100 pps)	I _{FP}		1	Α
	Input reverse voltage		V_{R}		5	V
	Input power dissipation		P_D		50	mW
	Input power dissipation derating $(T_a \ge 2)$	25 °C)	$\Delta P_D/\Delta T_a$		-0.5	mW/°C
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V_{OFF}		60	V
	ON-state current		I _{ON}		2	Α
	ON-state current derating $(T_a \ge 2)$	25 °C)	$\Delta I_{ON}/\Delta T_a$		-20	mA/°C
	ON-state current (pulsed) (t = 100 ms,	duty = 1/10)	I _{ONP}		6	Α
	Output power dissipation		Po		500	mW
	Output power dissipation derating $(T_a \ge 2)$	25 °C)	$\Delta P_{O}/\Delta T_{a}$		-5.0	mW/°C
	Junction temperature		Tj		125	°C
Common	Storage temperature		T_{stg}		-55 to 125	
	Operating temperature		T_{opr}		-40 to 85	
	Lead soldering temperature (10) s)	T_{sol}		260	
	Isolation voltage (AC, 60 s, R	R.H. ≤ 60 %)	BV_S	(Note 1)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V_{DD}		_	_	48	V
Input forward current	I _F		5	10	25	mA
ON-state current	I _{ON}		_	_	2	Α
Operating temperature	T _{opr}		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.



8. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.18	1.33	1.48	V
	Input reverse current	I _R		V _R = 5 V			10	μА
	Input capacitance	Ct		V = 0 V, f = 1 MHz		70		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	_	_	1	μА
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz		250		pF

9. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 1 A	_	0.5	3	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.1			mA
ON-state resistance	R _{ON}		$I_{ON} = 2 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	80	200	mΩ

10. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz		0.8		pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	5×10 ¹⁰	1014		Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	2500			Vrms

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

11. Switching Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 11.1.	_	0.8	5	ms
Turn-off time	t _{OFF}		$R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$		0.3	1	
Turn-on time	t _{ON}		See Fig. 11.1.	1	0.4	3	
Turn-off time	t _{OFF}		$R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 10 mA$		0.3	1	

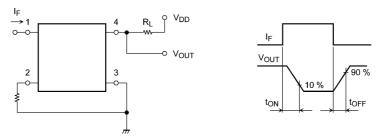


Fig. 11.1 Switching Time Test Circuit and Waveform



12. Characteristics Curves and Circuit Connections

12.1. Characteristics Curves (Note)

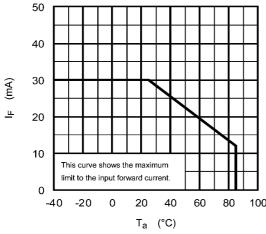


Fig. 12.1.1 I_F - T_a

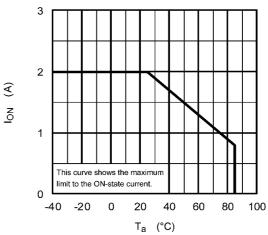


Fig. 12.1.2 I_{ON} - T_a

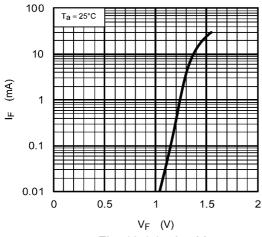


Fig. 12.1.3 I_F - V_F

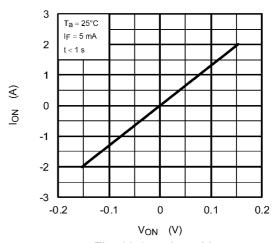


Fig. 12.1.4 I_{ON} - V_{ON}

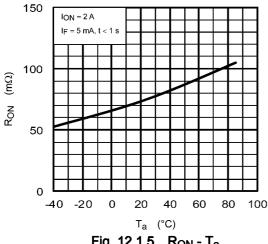


Fig. 12.1.5 R_{ON} - T_a

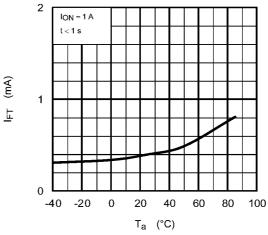
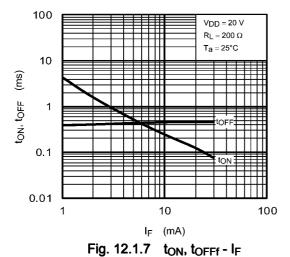


Fig. 12.1.6 I_{FT} - T_a





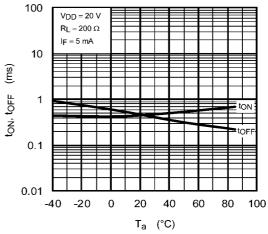
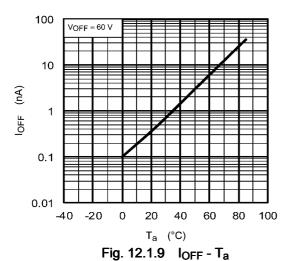


Fig. 12.1.8 t_{ON}, t_{OFF} - T_a

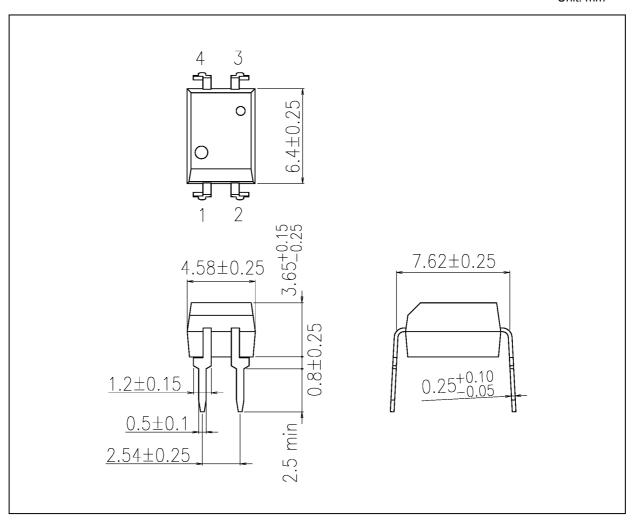


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B2S	



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